

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	((("6123781") or ("4863877")).PN.	USPAT; USOCR	OR	OFF	2008/01/22 09:52
L2	2	"20040040628"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 09:52
L3	4	L1 L2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 09:52
L4	4	L3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:04
L5	4	4 and anneal\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:05
L6	3	4 and (magnet\$7 field)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:17
L7	21	((magnet\$7 field) with anneal\$5 with wafer).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:10
L8	3	((magnet\$7 field) with anneal\$5 with wafer and (flash lamp laser flash\$5 rta) with anneal\$5).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:30
L9	1	4 and 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:13
L10	4	("5496759" "6027948" "6048739").PN. OR ("6918965").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/22 10:16

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L11	3	10 and (magnet\$7 field) and anneal\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:21
L12	1	10 and (magnet\$7 field) same pin\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:21
L13	2	10 and (magnet\$7 field) same (pin\$4 fix\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:21
L14	3	8 and (pin\$5 fix\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:29
L15	0	14 and (pin\$5 fix\$5) with (flash lamp laser flash\$5 rta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:33
L16	3	14 and (pin\$5 fix\$5) with anneal\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:35
L17	3	14 and (pin\$5 fix\$5) with anneal\$5 and heat\$4 with anneal\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:53
L18	2974	148/108.ccls. 438/3.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:53
L19	2	"20040040628"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 10:57
L20	1	19 and local\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:00

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L21	1	19 and local\$4 and (anneal\$4 near5 layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:00
L22	0	19 and degree	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:01
L23	1	19 and anneal\$4 with c	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:01
L24	0	19 and ("300" "400" "500")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:01
L25	40	tuttle.in. and anneal\$4 and wafer and magnet\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:05
L26	39	tuttle.in. and anneal\$4 and wafer and magnet\$5 and (pin\$5 fix\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:05
L27	4	tuttle.in. and anneal\$5 and wafer and magnet\$5 and ((pin\$5 fix\$5) with (magnet\$5 anneal\$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:20
L28	4	27 and laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:21
L29	4	27 and local\$5 with (magnet\$5 field)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:24
L30	5	"20040040628" "20050133118"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:24

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L31	3	30 and local\$5 with (magnet\$5 field)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:24
L32	0	30 and local\$5 with (magnet\$5 field) with (pin\$5 fix\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:25
L33	3	30 and local\$5 with (magnet\$5 field) same (pin\$5 fix\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:26
L34	3	30 and local\$5 with (magnet\$5 field) same (pin\$5 fix\$5 align\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:36
L35	1	anneal\$4 with (spot adj spot)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:36
L36	27	anneal\$4 with (line adj line)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:40
L37	28	35 36	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:38
L38	8	37 and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:37
L39	20	37 not 38	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:38
L40	302	wafer with ((line adj line) (spot adj spot))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:40

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L41	28	wafer with ((line adj line) (spot adj spot)) same laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:41
L42	1	wafer with ((line adj line) (spot adj spot)) same laser with (heat\$4 treat\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:54
L43	2	"20050087519"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:54
L44	1	43 and magnet\$5 with less	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:56
L45	2	43 and magnet\$5 with entir\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:57
L46	5	30 and magnet\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:46
L47	3373	(Helmholtz coil) with magnet\$7 same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:58
L48	51	Helmholtz with magnet\$7 same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 11:59
L49	5	Helmholtz with magnet\$7 same wafer same (pin\$4 fix\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:07
L50	193	anneal\$5 with (magnet\$7 pin\$5) with ("300" "400" "500" "350" "450") with c	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:08

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L51	216	anneal\$5 with (magnet\$7 pin\$5) with ("300" "400" "500" "350" "450") with (c celcius centigrade)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:11
L52	8	51 same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:10
L53	8	51 and anneal\$5 with wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:49
L54	217	anneal\$5 with (magnet\$7 pin\$5) with ("300" "325" "375" "425" "475" "400" "500" "350" "450") with (c celcius centigrade)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:11
L55	218	anneal\$5 with (magnet\$7 pin\$5) with ("275" "525" "300" "325" "375" "425" "475" "400" "500" "350" "450") with (c celcius centigrade)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:32
L56	66	55 and magnet\$5 with layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:12
L57	11	55 and magnet\$5 with layer same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:17
L58	5	55 and magnet\$5 with layer same wafer and sec\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:18
L59	30	anneal\$5 with magnet\$5 with layer same wafer same sec\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:20
L60	0	anneal\$5 with magnet\$5 with layer same wafer same ("1" "60") near3 sec\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:19

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L61	17	anneal\$5 with magnet\$5 with layer same wafer same min\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:21
L62	15	55 and cool\$4 with (liquid helium nitrogen argon vacuum)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:32
L63	1	55 and cool\$4 with (liquid helium nitrogen argon vacuum) same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:30
L64	175	anneal\$5 with wafer with ("275" "525" "300" "325" "375" "425" "475" "400" "500" "350" "450") with (c celcius centigrade)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:35
L65	12	64 and cool\$4 with (liquid helium nitrogen argon vacuum) same wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:33
L66	172	anneal\$5 with wafer same cool\$4 with (liquid helium nitrogen argon vacuum)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:36
L67	17	anneal\$5 near2 wafer same cool\$4 near2 (liquid helium nitrogen argon vacuum)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:36
L68	5	30 and cool\$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:46
L69	0	laser with anneal\$5 with wafer same cool\$4 with (helium nitrogen argon)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:50
L70	0	laser with anneal\$5 with wafer same cool\$4 with (vacuum liquid)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 12:50

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L71	3	laser with anneal\$5 with wafer and wafer with cool\$4 with (vacuum liquid helium nitrogen argon)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 13:17
L72	1	("5763108").PN.	USPAT; USOCR	OR	OFF	2008/01/22 13:17